



PJD60N06

60V N-Channel Enhancement Mode MOSFET

Voltage **60 V**

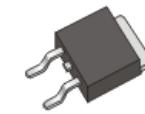
Current **60 A**

Features

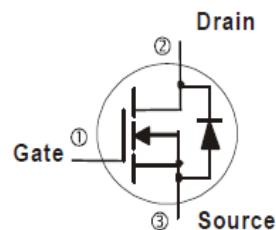
- RDS(ON) , VGS@10V, ID@30A<10mΩ
- High switching speed
- Improved dv/dt capability
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2011/65/EU directive.
- Green molding compound as per IEC61249 Std.. (Halogen Free)

Mechanical Data

- Case : TO-252AA Package
- Terminals : Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.0104 ounces, 0.297grams



TO-252AA



Maximum Ratings and Thermal Characteristics (TA=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS
Drain-Source Voltage		V _{DS}	60	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _C =25°C	I _D	60	A
	T _C =100°C		38	
Pulsed Drain Current ^(Note 1)	T _C =25°C	I _{DM}	240	
Power Dissipation	T _C =25°C	P _D	72	W
	T _C =100°C		29	
Continuous Drain Current	T _A =25°C	I _D	10	A
	T _A =70°C		8	
Power Dissipation	T _A =25°C	P _D	2.0	W
Power Dissipation	T _A =70°C		1.3	
Single Pulse Avalanche Energy ^(Note 6)		E _{AS}	180	mJ
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55~150	°C
Typical Thermal Resistance (Note 4,5)	Junction to Case	R _{θJC}	1.7	°C/W
	Junction to Ambient	R _{θJA}	62.5	

- Limited only By Maximum Junction Temperature



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Electrical Characteristics ($T_A=25^\circ C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	60	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	2.8	3.5	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=30A$	-	8.4	10	$m\Omega$
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=48V, V_{GS}=0V$	-	-	1.0	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Dynamic <small>(Note 7)</small>						
Total Gate Charge	Q_g	$V_{DS}=48V, I_D=25A,$ $V_{GS}=10V$ <small>(Note 1,2)</small>	-	52	-	nC
Gate-Source Charge	Q_{gs}		-	11	-	
Gate-Drain Charge	Q_{gd}		-	15	-	
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V,$ $f=1.0MHz$	-	2904	-	pF
Output Capacitance	C_{oss}		-	241	-	
Reverse Transfer Capacitance	C_{rss}		-	112	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=30V, I_D=30A,$ $V_{GS}=10V,$ $R_G=3.3\Omega$ <small>(Note 1,2)</small>	-	18	-	ns
Turn-On Rise Time	t_r		-	48	-	
Turn-Off Delay Time	$t_{d(off)}$		-	54	-	
Turn-Off Fall Time	t_f		-	18	-	
Drain-Source Diode						
Maximum Continuous Drain-Source Diode Forward Current	I_S	---	-	-	60	A
Diode Forward Voltage	V_{SD}	$I_S=1A, V_{GS}=0V$	-	0.7	1.2	V

NOTES :

1. Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics.
3. Repetitive rating, pulse width limited by junction temperature $T_J(MAX)=150^\circ C$. Ratings are based on low frequency and duty cycles to keep initial $T_J = 25^\circ C$.
4. The maximum current rating is package limited.
5. R_{QJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
6. The test condition is $L=0.1mH, I_{AS}=60A, V_{DD}=25V, V_{GS}=10V$
7. Guaranteed by design, not subject to production testing.



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TYPICAL CHARACTERISTIC CURVES

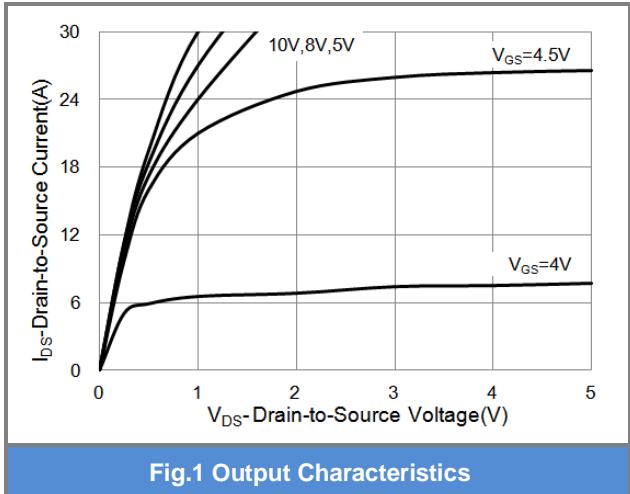


Fig.1 Output Characteristics

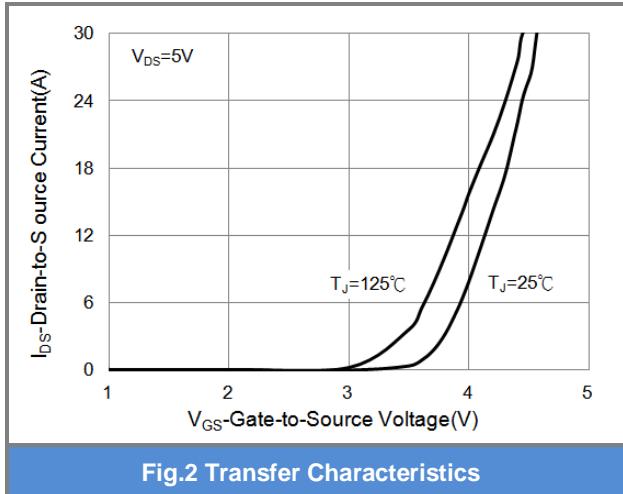


Fig.2 Transfer Characteristics

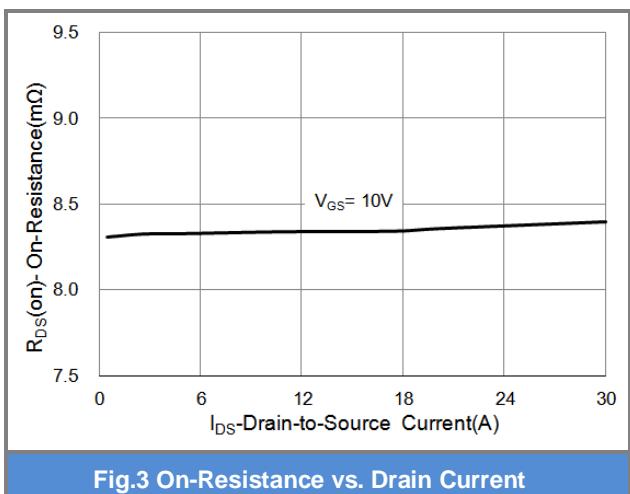


Fig.3 On-Resistance vs. Drain Current

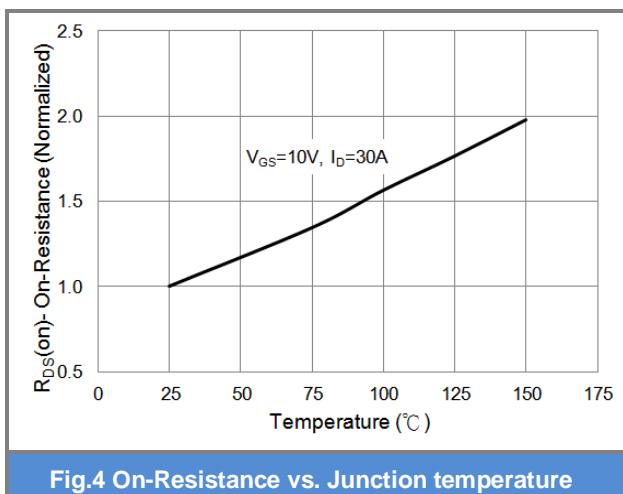


Fig.4 On-Resistance vs. Junction temperature

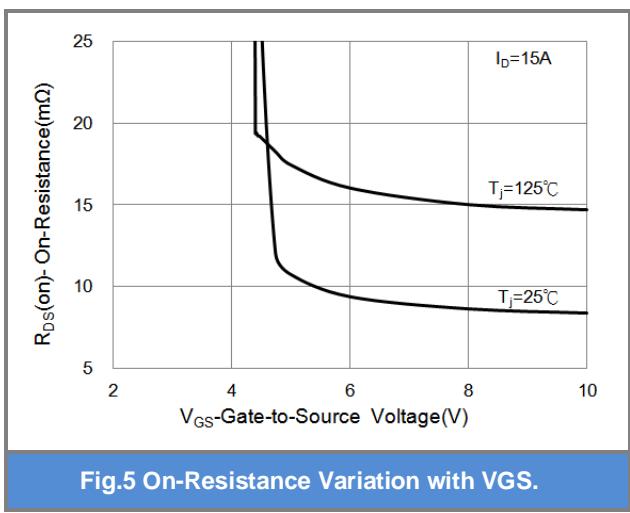


Fig.5 On-Resistance Variation with VGS

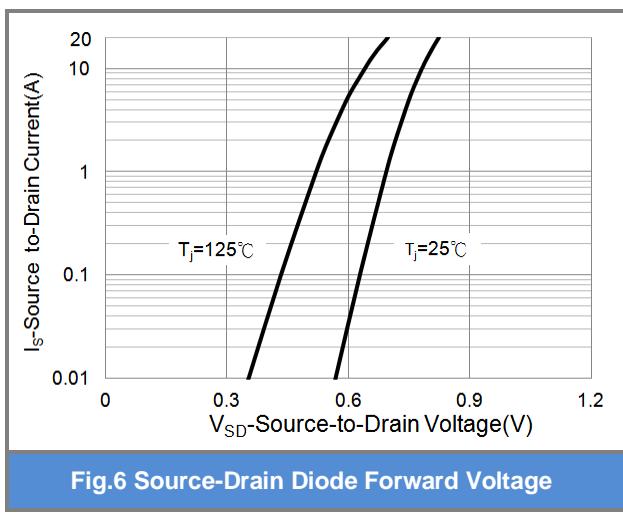


Fig.6 Source-Drain Diode Forward Voltage



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TYPICAL CHARACTERISTIC CURVES

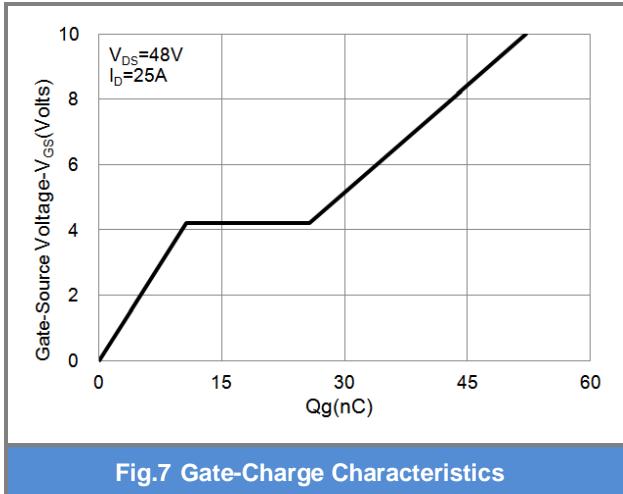


Fig.7 Gate-Charge Characteristics

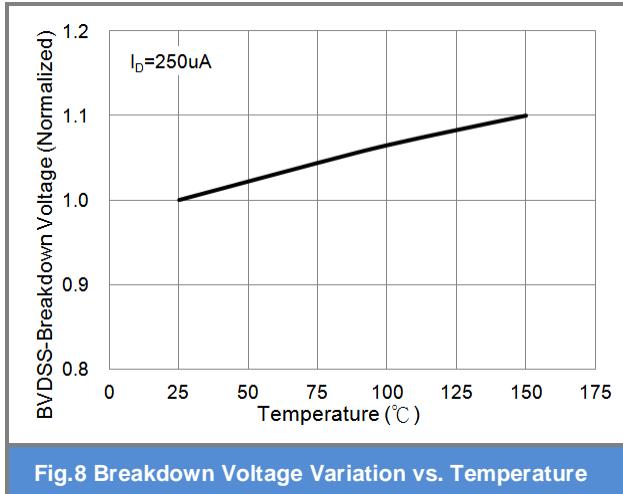


Fig.8 Breakdown Voltage Variation vs. Temperature

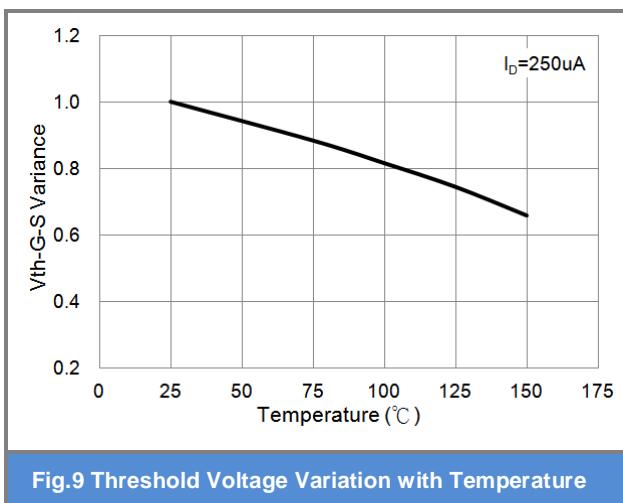


Fig.9 Threshold Voltage Variation with Temperature

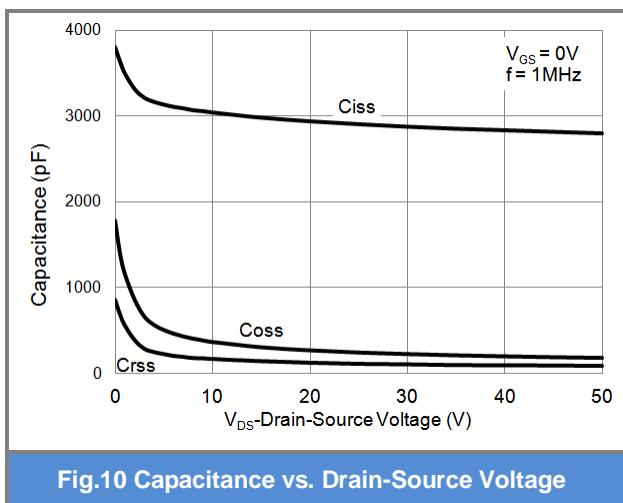


Fig.10 Capacitance vs. Drain-Source Voltage

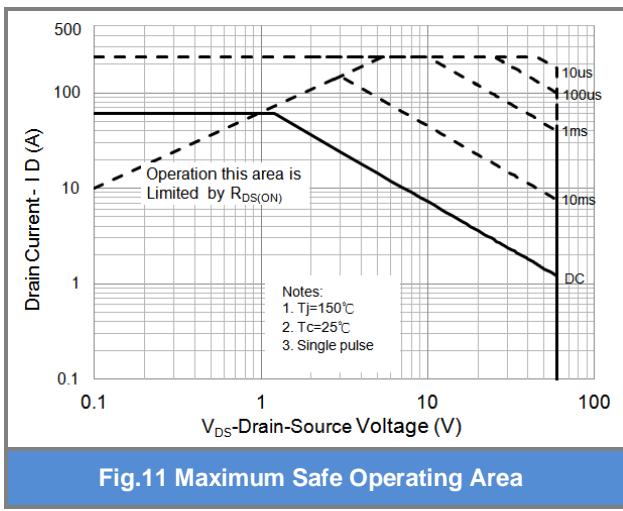


Fig.11 Maximum Safe Operating Area



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TYPICAL CHARACTERISTIC CURVES

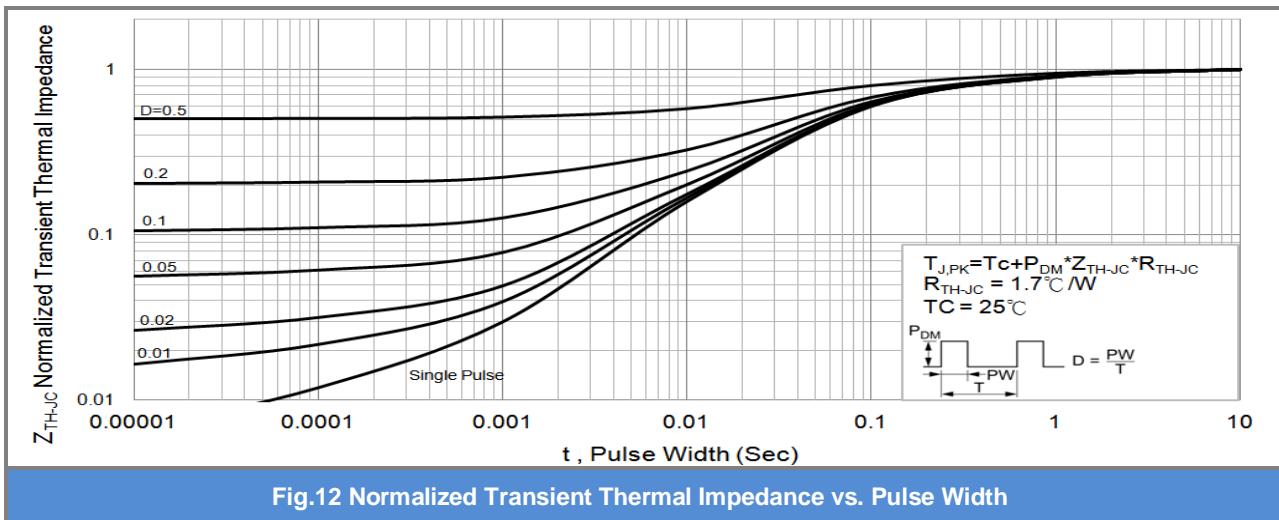
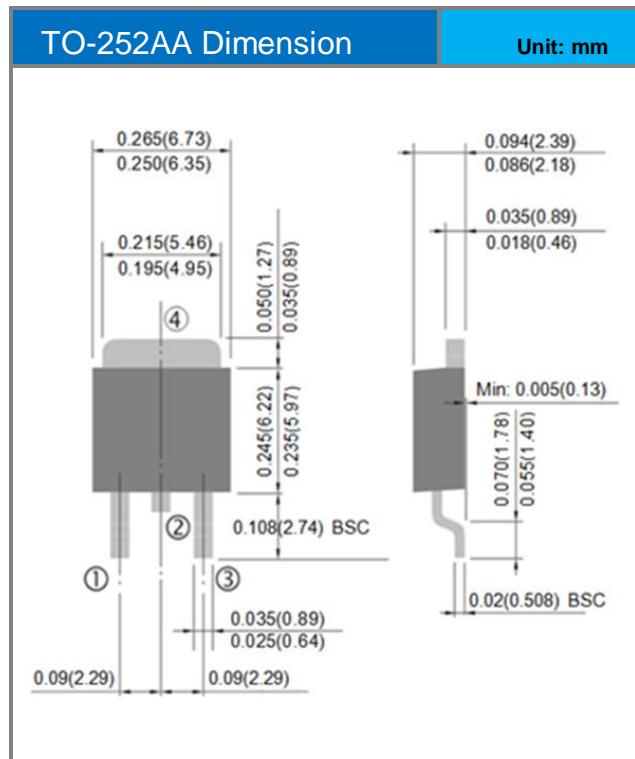


Fig.12 Normalized Transient Thermal Impedance vs. Pulse Width



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Packaging Information



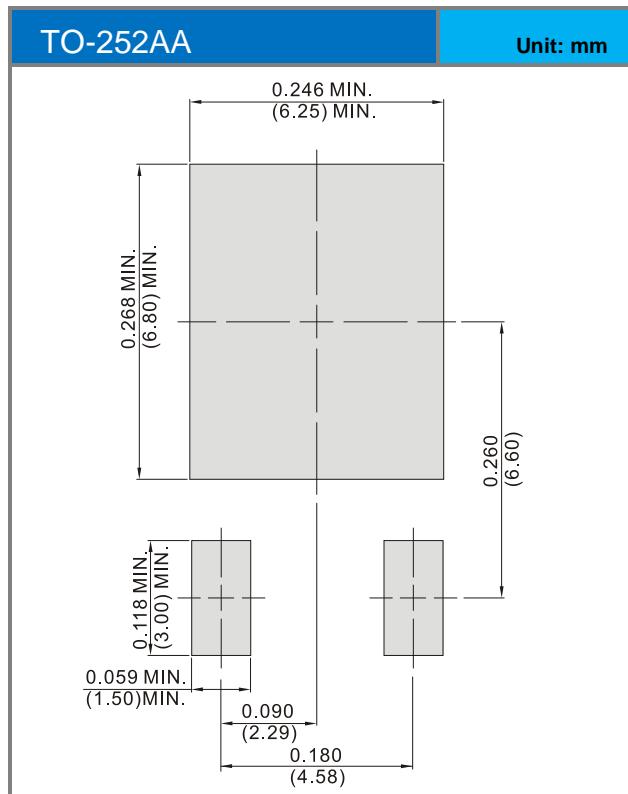


PJD60N06

PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing Type	Marking	Version
PJD60N06_L2_00001	TO-252AA	3,000pcs / 13" reel	D60N06	Halogen free

MOUNTING PAD LAYOUT





PJD60N06

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